

SPECIFICATION OF INFRARED LED CHIP

CN870-35P

[INFRARED]

1) Commodity Type and Physical Characteristics.

- | | | | |
|----------------------|--------------------|------------------|------------|
| 1. Material | GaAlAs/GaAlAs(DDH) | | |
| 2. Electrode | Top Side | P (anode) side | : Au Alloy |
| | Bottom Side | N (cathode) side | : Au Alloy |
| 3. Electrode Pattern | Fig.1 | | |
| 4. Chip Size | Fig.2 | | |
| 5. Chip Thickness | Fig.2 | | |
| 6. Emission Area | Fig.2 | | |

2) Electro-Optical Characteristics

parameters	symbol	condition	min.	typ.	max.	unit
Forward Voltage	V _f	I _f =20mA		1.45	1.7	V
Reverse Current	I _r	V _r =5V			10	uA
Power Intensity	P _o	I _f =20mA	3.0	4.5		mW
Peak Wavelength	λ _P	I _f =20mA	860	870	880	nm
Spectral Radiation Bandwidth	Δλ	I _f =20mA		40		nm
Rise Time	t _r	I _f =20mA		15		ns
Full time	t _f	I _f =20mA		10		ns

‡ Die shall be mounted on TO=18 gold header without resin coated.

[Unit: um

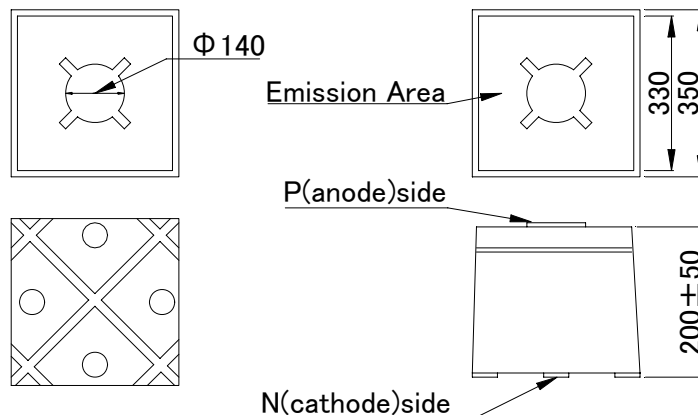


Fig.1 Electrode Pattern

Fig.2 Chip size and Emission Area